

## CONTACT

📍 San Diego, CA  
✉ [eddiamsamuels@gmail.com](mailto:eddiamsamuels@gmail.com)  
🌐 [eddiesamuels.com](http://eddiesamuels.com)  
in [linkedin.com/in/edsammy](https://www.linkedin.com/in/edsammy)  
🐙 [github.com/edsammy](https://github.com/edsammy)

## SKILLS

schematic capture

high speed routing

I2C

UART

SPI

board bringup

device verification

enclosure CAD

FDM & SLA 3D printing

production

part procurement

soldering

EagleCAD

Fusion360

Python

Git

Bash

# EDDIE SAMUELS

## EXPERIENCE

### comma.ai

#### *VP of Hardware*

2018 – 2019

- Managed a four person hardware team
- Utilized contract manufacturers to scale production to 10k units
- Schematic capture, part procurement, and high speed PCB routing (MIPI CSI, USB 3.0, PCIE) for next-gen product  
→ based on a Snapdragon 845 SOM after evaluating with Nvidia TX2
- Integrated Linux kernel drivers for I2C, SPI, and UART sensors
- Interfaced with Bash and Python flashing, testing, and setup tools

#### *Hardware Engineer*

2016 – 2018

- First hardware hire for the company
- Schematic capture, PCB routing, enclosure CAD, packaging design, and production execution for the panda CAN to USB and WiFi interface  
→ based on the ARM STM32F and ESP8266
- Enclosure CAD, analog fan controller design, and production execution for the eon driver development kit → based on Snapdragon 821 smartphones
- Designed and stabilized switched-mode power supplies (SMPS)
- Performed preproduction Device Verification Testing (DVT)
- Developed production phase assembly and testing rigs

### Lockheed Martin

#### *Associate Electrical Engineer*

2015 – 2016

- Performed PCB bringup, documentation, and system integration for Joint Strike Fighter test equipment
- Developed MATLAB automated test platform to search for spurious RF emission events

#### *Electrical Engineer Intern*

Summer 2014

- Part of a three member team chosen by Lockheed Martin and the New York NASA Space Grant Consortium
- Designed electrical platform for a teleoperated underwater rover
- Developed curriculum for STEM outreach program based on rover design

## EDUCATION

### University of Rochester

*B.S. in Electrical & Computer Engineering*

2011 – 2015